

PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,Tel: 886-2-2225-3733Fax: 886-2-2225-4800E-mail: para@para.com.twwww.paralighttaiwan.com

DATA SHEET

PART NO.: L-S2812LGCT-HQ

REV: <u>A / 0</u>

CUSTOMER'S APPROVAL :

DRAWING NO. : DS-31P-18-0108

DCC :

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PARA-FOR-068



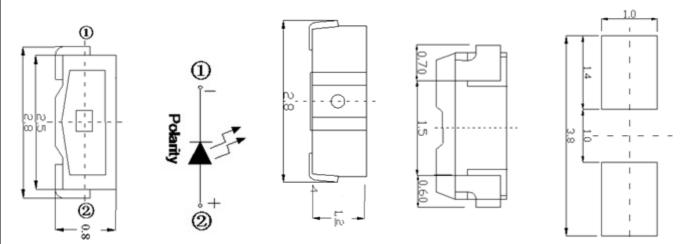
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Features

Package (L/W/H): 2.8x0.8x1.2 mm Ultra Bright Standard Green Water Clear Flat Mold EIA STD Package Meet ROHS, Green Product Compatible With SMT Automatic Equipment Compatible With Infrared Reflow Solder Process

Package Profile & Soldering PAD Suggested



Notes: 1. All dimensions are in millimeters

2. Tolerance is ± 0.10 mm unless otherwise noted

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Power Dissipation	Pd	90	mW	
Peak Forward Current	Ifp	100	mA	
DC Forward Current	IF	25	mA	
Reverse Voltage	VR	5	V	
Operating Temperature Range	Topr	$-30^{\circ}C \sim +85^{\circ}C$		
Storage Temperature Range	Tstg	$-40^{\circ}C \sim +90^{\circ}C$		
		Reflow soldering : $260 \degree C$, $10s$		
Soldering Condition	Tsol	Hand soldering : 300°C , 3s		
Electrostatic Discharge	ESD	2000 V		

Electrical Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV		720		mcd	IF = 20mA
Viewing Angle	201/2		120		deg	IF = 20mA
Dominant Wavelength	λd	515		527	nm	IF = 20mA
Peak Wavelength	λp		521		nm	IF = 20mA
Color Temperature	VF	2.8		3.4	V	IF = 20mA
Forward Voltage	IR			5	μΑ	VR = 5V
Spectral Line Half-Width	Δλ		35		nm	IF = 20mA
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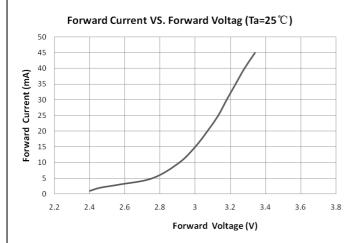
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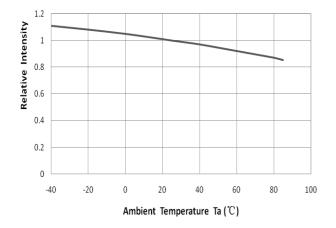
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Typical Electrical-Optical Characteristics Curves

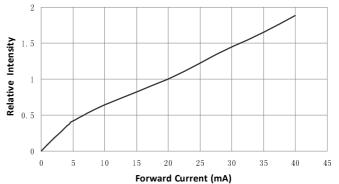


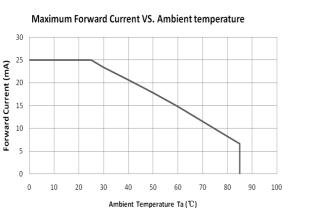
Spectrum Distribution (Ta=25°C) 1.2 1 **Relative Intensity** 0.8 0.6 0.4 0.2 0 430 480 730 780 380 530 580 630 680 Wavelength (nm)

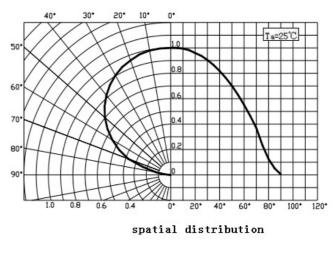
Relative Intensity VS. Ambient Temperature (Ta=25℃)



Relative Intensity VS. Forward Current (Ta=25℃)







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Bin Range of Luminous Intensity

Bin	Min	Max	Unit	Condition
P2	560	720		IF=20mA
Q1	720	900	MCD	
Q2	900	1150	MCD	
R1	1150	1400		

Notes: Tolerance of Luminous Intensity: ± 10%

Bin Range of Forward Voltgae

Bin	Min	Max	Unit	Condition
6	2.8	3.0		
7	3.0	3.2	V	IF=20mA
8	3.2	3.4		

Notes: Tolerance of Forward Voltage: $\pm 0.02V$

Bin Range of Wavelength

Bin	Min	Max	Unit	Condition
В	515	518		
С	518	521		IE-20 A
D	521	524	nm	IF=20mA
Е	524	527		

Notes: Tolerance of Wavelength: ± 1nm

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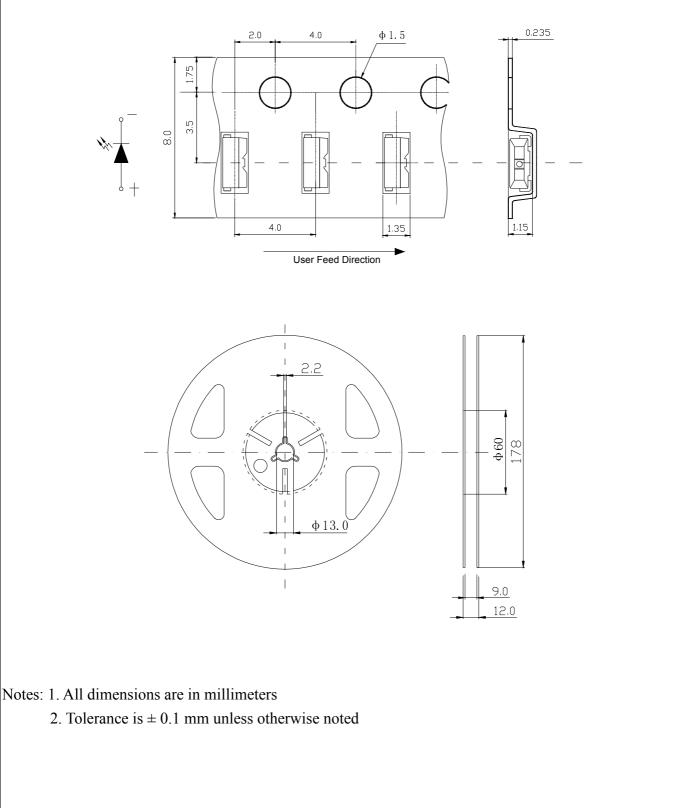
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Reel And Tape Dimensions



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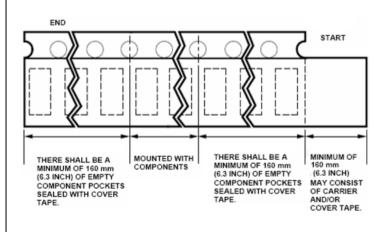
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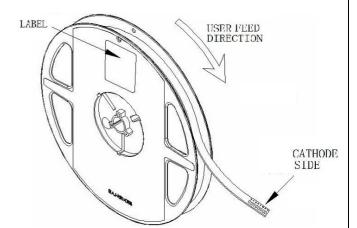


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Tape Leader & Trailer Dimensions And Reel:





Label Explanation



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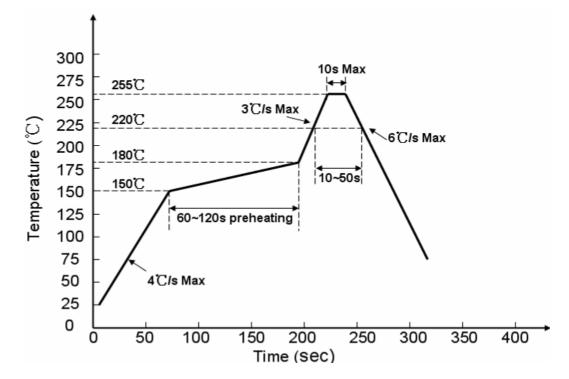
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Soldering Profile Suggested (For Lead Free Solder)



Reliability Test:

		25mA test Ta=		
	Operation Life	Under Room Temperature As Per Data Sheet Maximum Rating	1000 HRS (-24 HRS, +72 HRS)	MIL-STD-750D:1026 MIL-STD-883D:1005
Endurance Test H	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5°C,RH= 85%	1000 HRS (<u>+</u> 2 HRS)	JIS C 7021:B-1 JESD22-A101
	High Temperature Storage	Ta= 105±5℃	1000 HRS(-24HRS, +72 HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -40±5℃	1000 HRS(-24HRS, +72 HRS)	JIS C 7021:B-12



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	Temperature Cycling*	$100^{\circ}C \sim 25^{\circ}C \sim -40^{\circ}C \sim 25^{\circ}C_{*}$ 30mins 5mins 30mins 5mins *	100 Cycles₽	MIL-STD-202F: 107D+' MIL-STD-750D: 1051+'
Environmental testing↔	Thermal ↔ Shock+	IR-Reflow In-Board, 2 Times↓ 100±5℃ ~ -40℃±5℃↓ 10mins 10mins ↓	100 Cycles#	MIL-STD-202F: 107D +/ MIL-STD-750D:
	Reflow. Pb Free Process.	Peak temperature range 260℃ 10s max+ \$\varphi\$	ي به به	MIL-STD-750D: 2031.2+ ³ J-STD-020C+ ³

Criteria For Judging Damage

Test items≓	Symbol₽	Test Condition≓	لم Criteria For Judgement		
Test Ttems	0,1001+		Min⊷	Maxe	
Forward Voltage↔	VF*'	IF=20mA↔	ته	U. S. L) x1. 1.	
Reverse Current+	IRe	VR=5V~	ته	U. S. L) x2. 0.	
Luminous Flux#	mcd≁	IF=20mA⊷	L. S. L) x0. 7₽	ته	

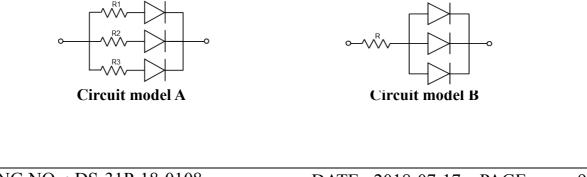
U.S.L: Upper standard level

L.S.L: Lower standard level

Cautions:

Application:

- 1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof
- 2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.



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- **3.** High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.
- 4. Rank Tolerance:

 REF / VF:
 $\pm 0.02V$

 CAT / IV:
 $\pm 10\%$

 X / Y:
 ± 0.005

Storage:

1. Before opening original package, it is recommended to store them in the following environment:

Temperature: $5^{\circ}C \sim 30^{\circ}C$, Humidity: 85%RH max. When the inventory over 3 months, Should be done before treatment using dehumidification, Temperature: $60^{\circ}C/8$ hours.

2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity

In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
 The LEDs should be used within 168hrs (7days) after opening the package. Once been mounted, soldering

should be quick.

5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7 days), baking treatment should be performed using the conditions: 60° C at least 24 hours.

ESD (Electrostatic Discharge)-Protection

A LED (especially the Blue, White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc.Some advice as below should be noticed:

1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs

2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded

(Grounding impedance value within $10\Omega)$

3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.

4.Use ionizer to neutralize the static charge during handling or operating.

5.All surfaces and objects within 1 ft close to LEDs measure less than 100V.

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Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary

Soldering

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 2.
- 2. Reflow soldering should not be done more than 2 times.
- **3.** Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- **5.** After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

Others

1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Harvatek's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.

3. The appearance and specifications of the product may be modified for improvement without prior notice.

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